

- ★ Super Low Gate Charge
- ★ Green Device Available
- ★ Excellent Cdv/dt effect decline
- ★ Advanced high cell density Trench technology

Product Summary



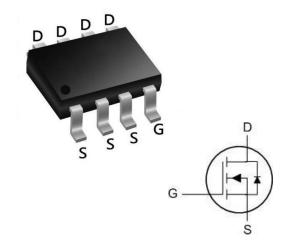
BVDSS	RDSON	ID
100V	88 mΩ	10A

Description

The XR10N10S is the highest performance trench N-ch MOSFETs with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The XR10N10S meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

SOP8 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	10	А
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	5	Α
I _{DM}	Pulsed Drain Current ²	10	Α
EAS	Single Pulse Avalanche Energy ³	6.1	mJ
P _D @T _A =25°C	Total Power Dissipation ³	5	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient ¹		125	°C/W
R _{eJC}	Thermal Resistance Junction-Case ¹		3.6	°C/W



Electrical Characteristics (TJ=25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charac	cteristic	1	1			
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	100	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =100V, V _{GS} =0V,	-	-	1.0	μA
I _{GSS}	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} =±20V	-	_	±100	nA
On Charac	cteristics		•			
V _{GS(th)}	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.0	1.5	2.5	V
Б	Static Drain-Source on-Resistance	V _{GS} =10V, I _D =3A	-	88	115	mΩ
$R_{DS(on)}$		V _{GS} =4.5V, I _D =2A	-	100	140	mΩ
Dynamic C	Characteristics					
C _{iss}	Input Capacitance	\\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	-	610	-	pF
C _{oss}	Output Capacitance	V _{DS} =25V, V _{GS} =0V,	-	40	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	25	-	pF
Q_g	Total Gate Charge	\/ _E0\/ _2A	-	12	-	nC
Q_{gs}	Gate-Source Charge	V_{DS} =50V, I_{D} =2A, V_{GS} =10V	-	2.2	-	nC
Q_{gd}	Gate-Drain("Miller") Charge	VGS-10V	-	2.5	-	nC
Switching	Characteristics					
t _{d(on)}	Turn-on Delay Time		-	7	-	ns
t _r	Turn-on Rise Time	V _{DS} =50V, I _D =3A,	-	5	-	ns
t _{d(off)}	Turn-off Delay Time	$R_G=1.8\Omega$, $V_{GS}=10V$	-	16	-	ns
t _f	Turn-off Fall Time		-	6	-	ns
Drain-Sou	rce Diode Characteristics and Maxim	um Ratings				
1	Maximum Continuous Drain to Source	Diode Forward				^
I _S	Current		-	-	3	A
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	12	Α
$V_{ ext{SD}}$	Drain to Source Diode Forward Voltage	V _{GS} =0V, I _S =3A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	21	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F =3A, dl/dt=100A/μs	-	21	-	nC

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



Typical Performance Characteristics

F' **1 0 1 1 0 1 1 1 1 1**

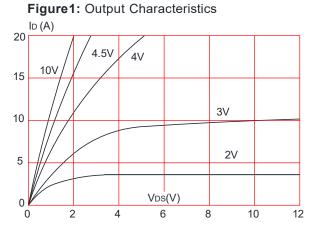


Figure 3:On-resistance vs. Drain Current

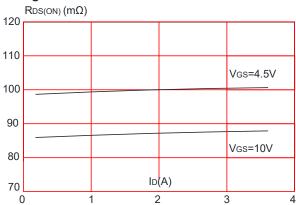


Figure 5: Gate Charge Characteristics

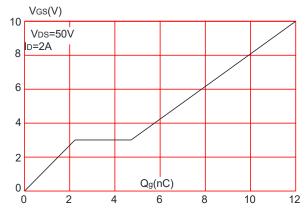


Figure 2: Typical Transfer Characteristics

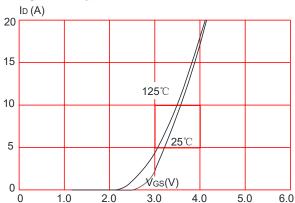


Figure 4: Body Diode Characteristics

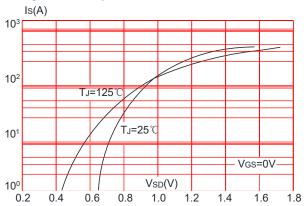


Figure 6: Capacitance Characteristics

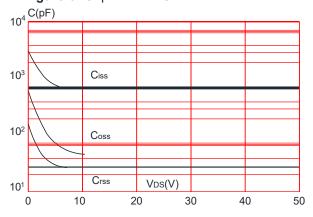




Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

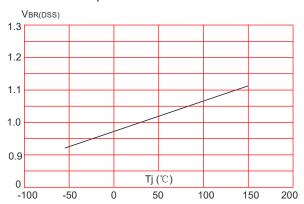


Figure 9: Maximum Safe Operating Area

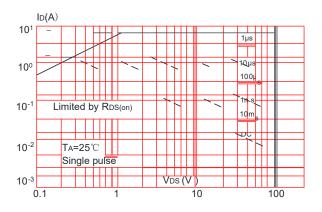


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

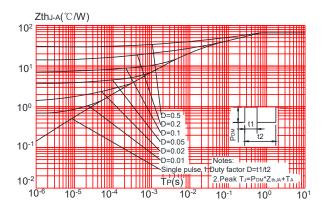


Figure 8: Normalized on Resistance vs. Junction Temperature

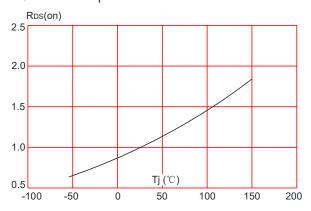
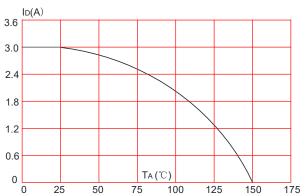
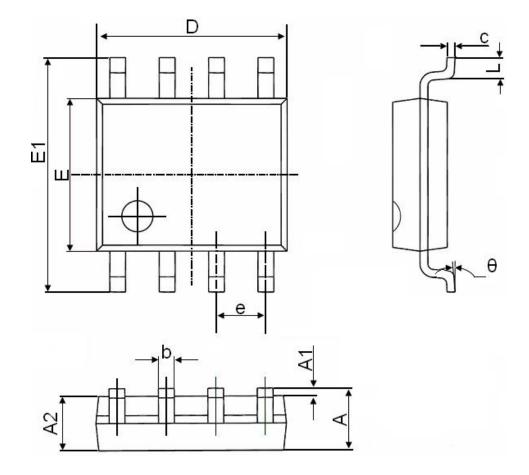


Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature





SOP-8 Package Information



Cumbal	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min.	Max.	Min.	Max.
Α	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
С	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
е	1.270	1.270(BSC) 0.050(BSC)		(BSC)
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°